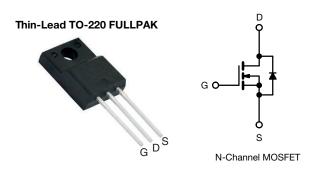
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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.088			
Q _g max. (nC)	53				
Q _{gs} (nC)	12				
Q _{gd} (nC)	11				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SiHA105N60EF-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600		
Gate-source voltage			V _{GS}	± 30	V	
Continuous durin surrent (T 150 °C) f	V_{GS} at 10 V $T_C = 25^{\circ}$	T _C = 25 °C	I _D	12		
Continuous drain current ($T_J = 150 \ ^\circ$ C) e	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		8	А	
Pulsed drain current ^a			I _{DM}	73	1	
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy ^b			E _{AS}	226	mJ	
Maximum power dissipation			PD	35	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		du (dt	70)//mm	
Reverse diode dv/dt ^d			dv/dt	50	V/ns	
Soldering recommendations (peak temperature) ^c	For 10 s			260	°C	
Mounting torque, M3 screw				0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 400 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

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DL TYP.	MAX.	UNIT	
-	65	°C/W	
-	3.6	0/10	
		- 65	

SPECIFICATIONS ($T_J = 25 \text{ °C}$, u					T \/2	NAAN	
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					1	1	r
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		Reference to 25 °C, $I_D = 1 \text{ mA}$		0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	3	-	5	V
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$ $V_{DS} = 480 V$, $V_{CS} = 0 V$		-	-	± 100	nA
	IGSS			-	-	± 1	μA
Zero gate voltage drain current	lana	V _{DS} =	$\label{eq:VDS} \begin{split} & V_{DS} = 480 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 480 \ V, \ V_{GS} = 0 \ V, \ T_J = 125 \ ^\circ C \\ \hline V_{GS} = 10 \ V \\ \hline & I_D = 13 \ A \end{split}$		-	1	μA
Zero gate voltage drain current	IDSS	V _{DS} = 480 V			-	2	mA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 13 A	-	0.088	0.102	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 20 V, I _D = 13 A	-	8	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	1804	-	
Output capacitance	C _{oss}	-	$V_{DS} = 100 V,$	-	82	-	1
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective output capacitance, energy related ^a	C _{o(er)}			-	63	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$v_{\rm DS} = 0$	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		407	-	
Total gate charge	Qg		V _{GS} = 10 V I _D = 11 A, V _{DS} = 480 V		35	53	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$			12	-	nC
Gate-drain charge	Q _{gd}			-	11	-	
Turn-on delay time	t _{d(on)}			-	20	40	- ns
Rise time	t _r	V _{DD} =	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 480 \; \text{V}, \; I_{\text{D}} = 13 \; \text{A}, \\ V_{\text{GS}} = 10 \; \text{V}, \; R_{\text{g}} = 9.1 \; \Omega \end{array}$		28	56	
Turn-off delay time	t _{d(off)}				39	78	
Fall time	t _f				19	38	
Gate input resistance	Rg	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s	•		•	•	•	
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	
Pulsed diode forward current	I _{SM}			-	-	73	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 13 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	125	250	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 13 \text{ A},$ di/dt = 100 A/µs, V _R = 400 V		-	0.8	1.6	μC
Reverse recovery current	I _{BBM}			-	12	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

2

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

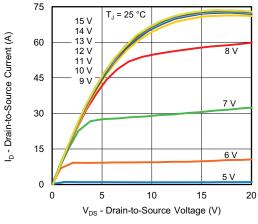


Fig. 1 - Typical Output Characteristics

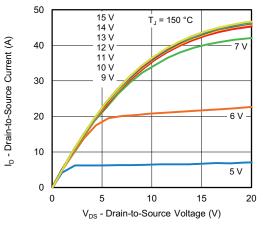


Fig. 2 - Typical Output Characteristics

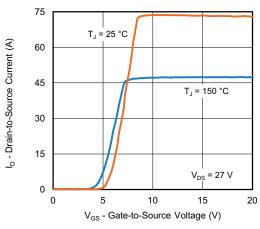


Fig. 3 - Typical Transfer Characteristics

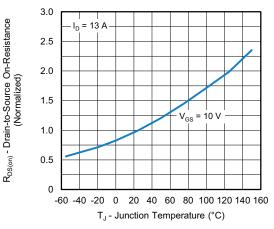


Fig. 4 - Normalized On-Resistance vs. Temperature

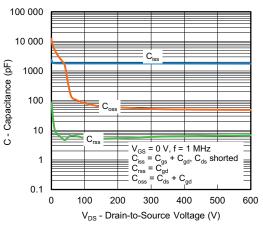
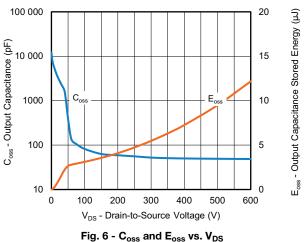


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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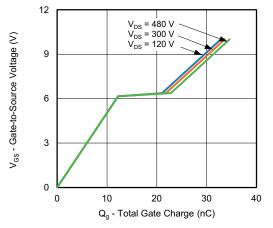


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

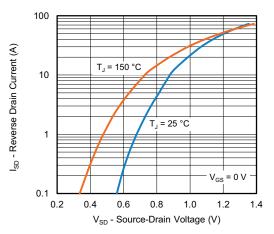


Fig. 8 - Typical Source-Drain Diode Forward Voltage

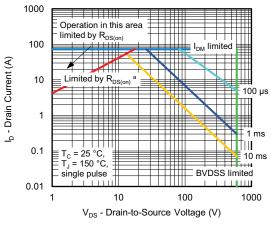


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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4

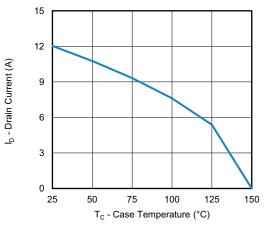


Fig. 10 - Maximum Drain Current vs. Case Temperature

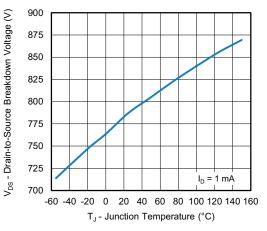


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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V_{DD}

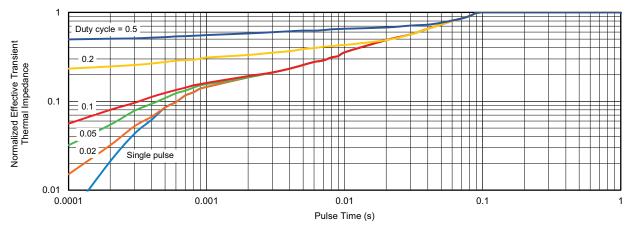


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

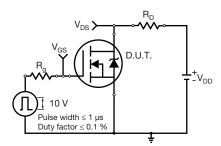


Fig. 13 - Switching Time Test Circuit

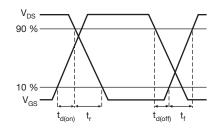


Fig. 14 - Switching Time Waveforms

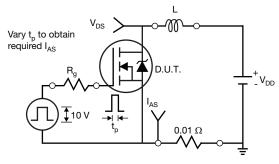


Fig. 15 - Unclamped Inductive Test Circuit

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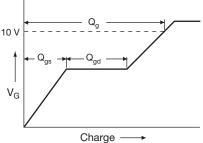


Fig. 17 - Basic Gate Charge Waveform

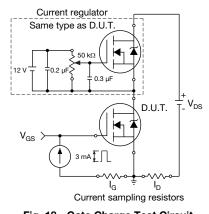
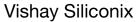


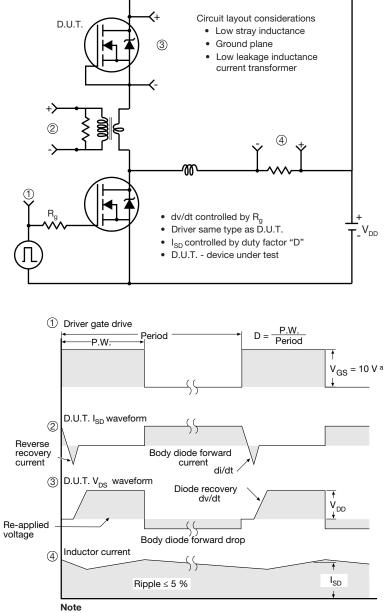
Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

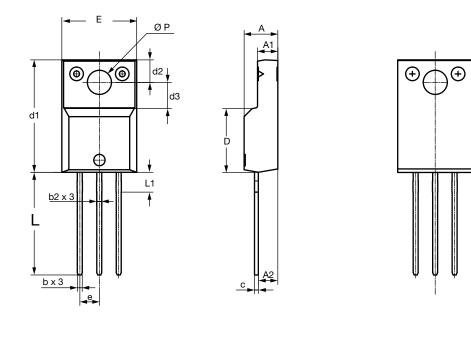
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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

Revision: 28-Dec-2020

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